

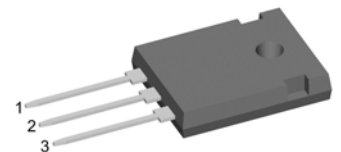
HiPerFRED²

preliminary

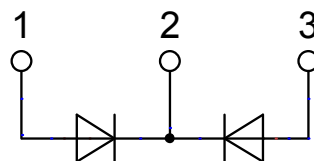
$$\begin{aligned} V_{RRM} &= 200\text{ V} \\ I_{FAV} &= 2 \times 40\text{ A} \\ t_{rr} &= 55\text{ ns} \end{aligned}$$

High Performance Fast Recovery Diode
Low Loss and Soft Recovery
Common Cathode

Part number

DPF80C200HB


Backside: cathode



Features / Advantages:

- Planar passivated chips
- Very low leakage current
- Very short recovery time
- Improved thermal behaviour
- Very low I_{rm} -values
- Very soft recovery behaviour
- Avalanche voltage rated for reliable operation
- Soft reverse recovery for low EMI/RFI
- Low I_{rm} reduces:
 - Power dissipation within the diode
 - Turn-on loss in the commutating switch

Applications:

- Antiparallel diode for high frequency switching devices
- Antisaturation diode
- Snubber diode
- Free wheeling diode
- Rectifiers in switch mode power supplies (SMPS)
- Uninterruptible power supplies (UPS)

Package: TO-247

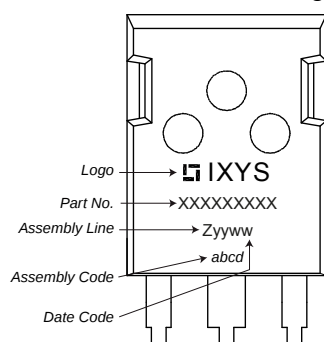
- Industry standard outline
- RoHS compliant
- Epoxy meets UL 94V-0

Fast Diode				Ratings				
Symbol	Definition	Conditions		min.	typ.	max.	Unit	
V _{RSM}	max. non-repetitive reverse blocking voltage	T _{VJ} = 25°C				200	V	
V _{RRM}	max. repetitive reverse blocking voltage	T _{VJ} = 25°C				200	V	
I _R	reverse current, drain current	V _R = 200 V	T _{VJ} = 25°C			1	μA	
		V _R = 200 V	T _{VJ} = 150°C			0.2	mA	
V _F	forward voltage drop	I _F = 40 A	T _{VJ} = 25°C			1.22	V	
		I _F = 80 A				1.45	V	
		I _F = 40 A	T _{VJ} = 150°C			0.95	V	
		I _F = 80 A				1.20	V	
I _{FAV}	average forward current	T _C = 145°C rectangular d = 0.5	T _{VJ} = 175°C			40	A	
V _{F0}	threshold voltage	} for power loss calculation only				0.67	V	
r _F	slope resistance					5.8	mΩ	
R _{thJC}	thermal resistance junction to case					0.7	K/W	
R _{thCH}	thermal resistance case to heatsink				0.25		K/W	
P _{tot}	total power dissipation	T _C = 25°C				215	W	
I _{FSM}	max. forward surge current	t = 10 ms; (50 Hz), sine; V _R = 0 V		T _{VJ} = 45°C		560	A	
C _J	junction capacitance	V _R = 100 V f = 1 MHz		T _{VJ} = 25°C	81		pF	
I _{RM}	max. reverse recovery current	} I _F = 40 A; V _R = 100 V -di _F /dt = 200 A/μs		T _{VJ} = 25°C		6	A	
				T _{VJ} = 125°C		11	A	
t _{rr}	reverse recovery time			T _{VJ} = 25°C		55	ns	
				T _{VJ} = 125°C		85	ns	

preliminary

Package TO-247			Ratings			
Symbol	Definition	Conditions	min.	typ.	max.	Unit
I_{RMS}	RMS current	per terminal ¹⁾			70	A
T_{VJ}	virtual junction temperature		-55		175	°C
T_{op}	operation temperature		-55		150	°C
T_{stg}	storage temperature		-55		150	°C
Weight				6		g
M_D	mounting torque		0.8		1.2	Nm
F_C	mounting force with clip		20		120	N

Product Marking



Part number

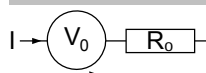
D = Diode
 P = HiPerFRED
 F = ultra fast
 80 = Current Rating [A]
 C = Common Cathode
 200 = Reverse Voltage [V]
 HB = TO-247AD (3)

Ordering	Part Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	DPF80C200HB	DPF80C200HB	Tube	30	508214

Similar Part	Package	Voltage class
DPF60C200HJ	ISOPLUS247 (3)	200

Equivalent Circuits for Simulation

* on die level

 $T_{VJ} = 175\text{ °C}$ 

Fast Diode

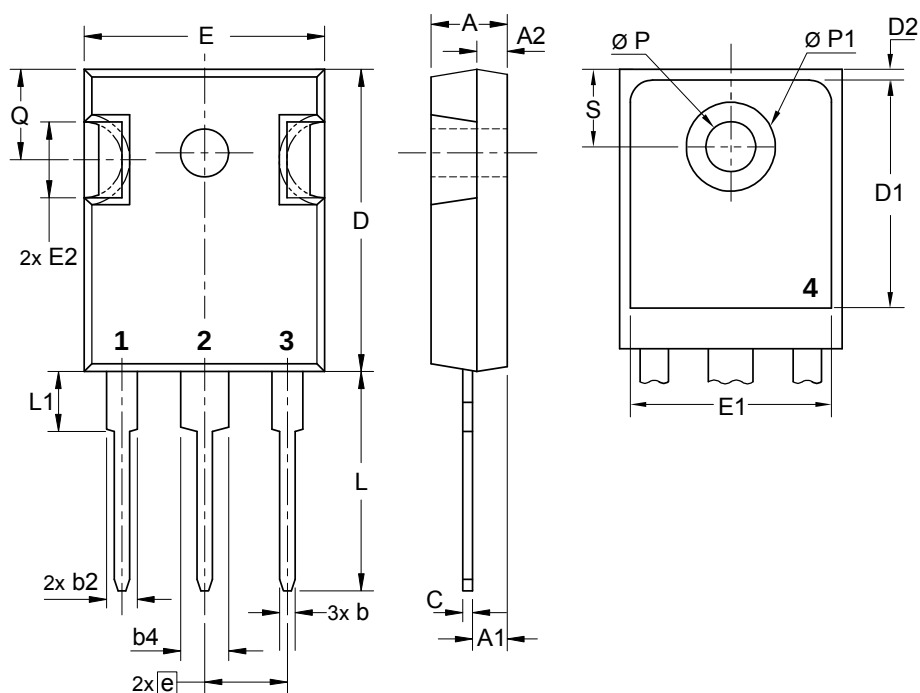
 $V_{0\max}$ threshold voltage 0.67

V

 $R_{0\max}$ slope resistance * 3.2

mΩ

Outlines TO-247



Sym.	Inches		Millimeter	
	min.	max.	min.	max.
A	0.185	0.209	4.70	5.30
A1	0.087	0.102	2.21	2.59
A2	0.059	0.098	1.50	2.49
D	0.819	0.845	20.79	21.45
E	0.610	0.640	15.48	16.24
E2	0.170	0.216	4.31	5.48
e	0.215	BSC	5.46	BSC
L	0.780	0.800	19.80	20.30
L1	-	0.177	-	4.49
Ø P	0.140	0.144	3.55	3.65
Q	0.212	0.244	5.38	6.19
S	0.242	BSC	6.14	BSC
b	0.039	0.055	0.99	1.40
b2	0.065	0.094	1.65	2.39
b4	0.102	0.135	2.59	3.43
c	0.015	0.035	0.38	0.89
D1	0.515	-	13.07	-
D2	0.020	0.053	0.51	1.35
E1	0.530	-	13.45	-
Ø P1	-	0.29	-	7.39

